



N-Channel Super Junction Power MOSFET III

General Description

The series of devices use advanced trench gate super junction technology and design to provide excellent R_{DS(ON)} with low gate charge. This super junction MOSFET fits the industry's AC-DC SMPS requirements for PFC, AC/DC power conversion, and industrial power applications.

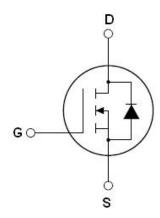
Features

- New technology for high voltage device
- Low on-resistance and low conduction losses
- Small package
- Ultra Low Gate Charge cause lower driving requirements
- 100% Avalanche Tested
- ROHS compliant

Application

- Power factor correction (PFC)
- Switched mode power supplies(SMPS)
- Uninterruptible Power Supply (UPS)

V _{DS}	700	V
R _{DS(ON)TYP}	330	mΩ
I_D	11.5	A



Schematic diagram

Package Marking And Ordering Information

Device	Device Package	Marking
NCE70T360K	TO-252	NCE70T360K
NCE70T360I	TO-251	NCE70T360I



TO-252

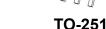




Table 1. Absolute Maximum Ratings (T_C=25℃)

Parameter	Symbol	Value	Unit
Drain-Source Voltage (Vgs=0V)	VDS	700	V
Gate-Source Voltage (V _{DS} =0V) AC (f>1 Hz)	V _G s	±30	V
Continuous Drain Current at T _C =25°C	I _{D (DC)}	11.5	А
Continuous Drain Current at T _C =100°C	I _{D (DC)}	7	Α
Pulsed drain current (Note 1)	I _{DM} (pluse)	46	Α
Maximum Power Dissipation(T _C =25℃)	P _D	101	W
Derate above 25°C		0.97	w/°C
Single pulse avalanche energy (Note2)	Eas	144	mJ
Avalanche current ^(Note 1)	I _{AR}	6	А
Repetitive Avalanche energy , t_{AR} limited by T_{jmax} (Note 1)	E _{AR}	0.5	mJ



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Parameter	Symbol	Value	Unit
Drain Source voltage slope, V _{DS} ≤480 V,	dv/dt	50	V/ns
Reverse diode dv/dt, $V_{DS} \leq 480 \text{ V,I}_{SD} < I_{D}$	dv/dt	15	V/ns
Operating Junction and Storage Temperature Range	T_{J}, T_{STG}	-55+150	°C

Table 2. Thermal Characteristic

Parameter	Symbol	Value	Unit
Thermal Resistance, Junction-to-Case (Maximum)	R _{thJC}	1.24	°C /W
Thermal Resistance, Junction-to-Ambient (Maximum)	R _{thJA}	62	°C /W

Table 3. Electrical Characteristics (TA=25 ℃ unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
On/off states			•		•	
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =250μA	700			V
Zero Gate Voltage Drain Current(Tc=25℃)	I _{DSS}	V _{DS} =700V,V _{GS} =0V		0.05	1	μA
Zero Gate Voltage Drain Current(Tc=125℃)	I _{DSS}	V _{DS} =700V,V _{GS} =0V			100	μA
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±20V,V _{DS} =0V			±100	nA
Gate Threshold Voltage	V _{GS(th)}	$V_{DS}=V_{GS}$, $I_{D}=250\mu A$	3	3.5	4	V
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =10V, I _D =7A		330	390	mΩ
Dynamic Characteristics					,	
Input Capacitance	C _{lss})/ F0)/)/ 0)/		870		pF
Output Capacitance	Coss	V_{DS} =50V, V_{GS} =0V,		54		pF
Reverse Transfer Capacitance	Crss	F=1.0MHz		1.8		pF
Total Gate Charge	Qg	1/ 400// 44.54		19		nC
Gate-Source Charge	Qgs	V _{DS} =480V,I _D =11.5A,		6		nC
Gate-Drain Charge	Q _{gd}	V _{GS} =10V		6.5		nC
Switching times	<u>'</u>				•	
Turn-on Delay Time	t _{d(on)}			12		nS
Turn-on Rise Time	t _r	V _{DD} =420V,I _D =5.5A,		9		nS
Turn-Off Delay Time	t _{d(off)}	$R_G=3\Omega,V_{GS}=10V$		61	70	nS
Turn-Off Fall Time	t _f			11	14	nS
Source- Drain Diode Characteristics			•		•	
Source-drain current(Body Diode)	I _{SD}	T 05°0			11.5	Α
Pulsed Source-drain current(Body Diode)	I _{SDM}	T _C =25°C			46	Α
Forward on voltage	V _{SD}	Tj=25°C,I _{SD} =11.5A,V _{GS} =0V		0.9	1.2	V
Reverse Recovery Time t _{rr}			220		nS	
Reverse Recovery Charge	Qrr	Tj=25°C,I _F =5.8A,		2.2		uC
Peak Reverse Recovery Current	I _{rrm}	di/dt=100A/μs		19		Α

Notes: 1.Repetitive Rating: Pulse width limited by maximum junction temperature

^{2.} Tj=25 $^{\circ}$ C,VDD=50V,VG=10V, R_G=25 Ω



TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS (curves)

Figure 1. Safe operating area

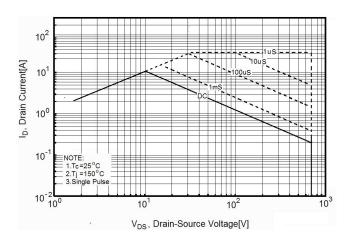


Figure 3. Source-Drain Diode Forward Voltage

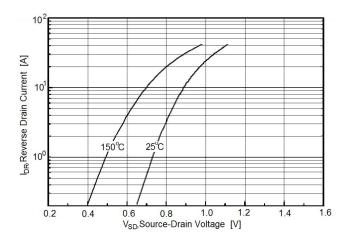


Figure 5. Transfer characteristics

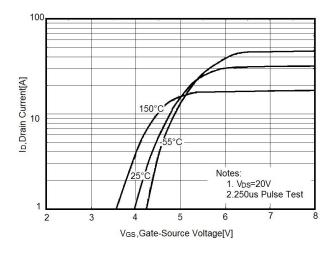


Figure 2. Transient Thermal Impedance

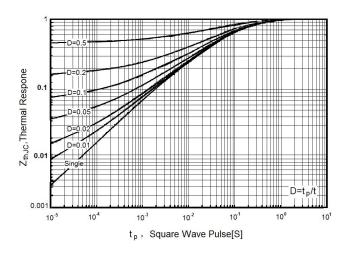


Figure 4. Output characteristics

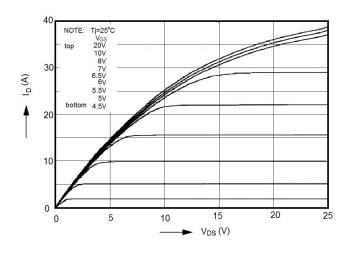
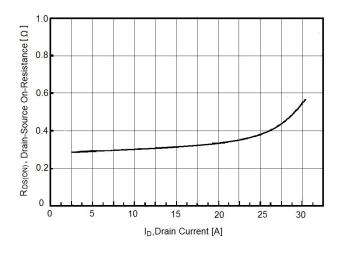


Figure 6. Static drain-source on resistance





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Figure 7. R_{DS(ON)} vs Junction Temperature

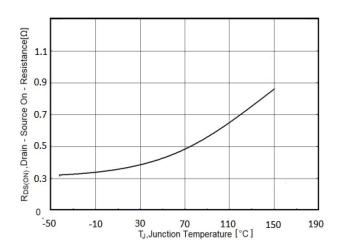


Figure8. BV_{DSS} vs Junction Temperature

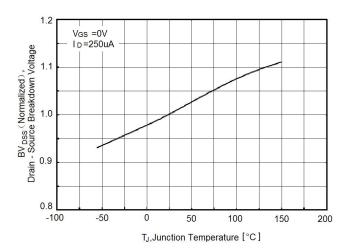


Figure 9. Maximum ID vs Junction Temperature

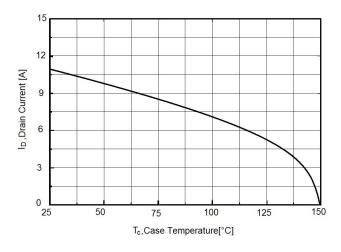


Figure 10. Gate charge waveforms

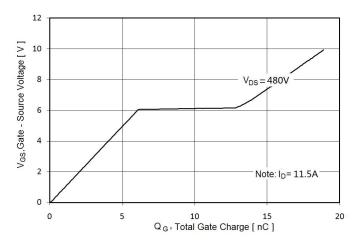
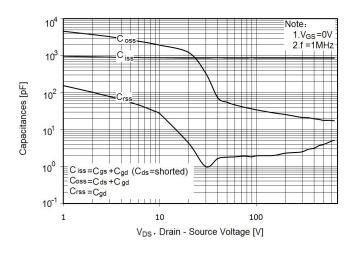


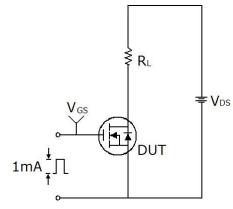
Figure 11. Capacitance

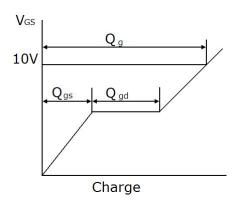




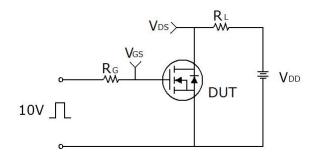
Test circuit

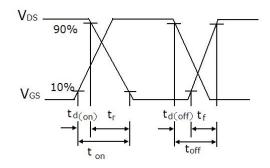
1) Gate charge test circuit & Waveform



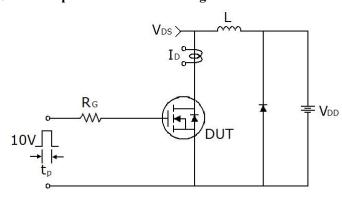


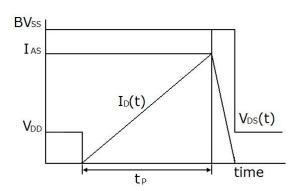
2) Switch Time Test Circuit:





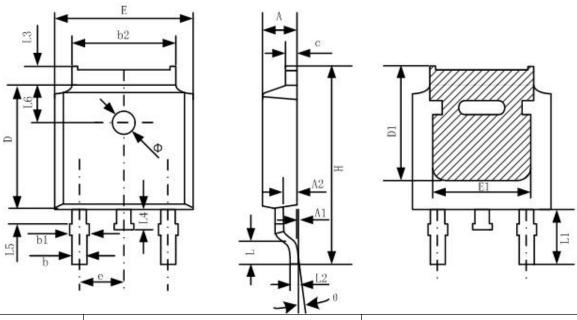
3) Unclamped Inductive Switching Test Circuit & Waveforms







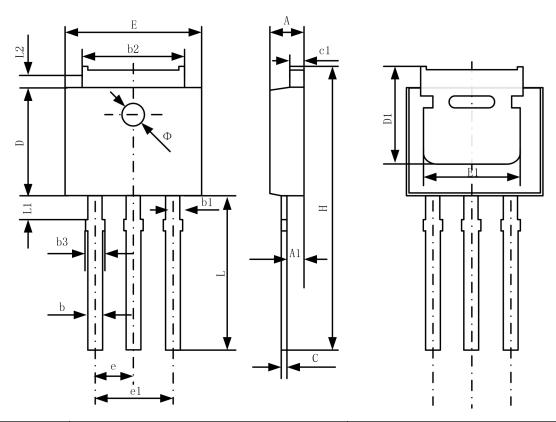
TO-252-2 Package Information



Symbol	Dimensions I	n Millimeters	Dimensions In Inches		
Symbol	Min.	Max.	Min.	Max.	
Α	2.20	2.38	0.087	0.094	
A1	0.00	0.10	0.000	0.004	
A2	0.90	1.10	0.035	0.043	
b	0.72	0.85	0.028	0.033	
b1	0.72	0.90	0.028	0.035	
b2	5.13	5.46	0.202	0.215	
С	0.47	0.60	0.019	0.024	
D	6.00	6.20	0.236	0.244	
D1	5.25		0.207		
E	6.50	6.70	0.256	0.264	
E1	4.70		0.185		
e	2.19	2.39	0.086	0.094	
Н	9.80	10.40	0.386	0.409	
L	1.40	1.70	0.055	0.067	
L1	2.90	REF	0.114 REF		
L2	0.508	BSC	0.020 BSC		
L3	0.90	1.25	0.035	0.049	
L4	0.60	1.00	0.024	0.039	
L5	0.15	0.75	0.006	0.030	
L6	1.80 REF		0.071 REF		
Ф	1.20	1.40	0.047	0.055	
θ	0°	8°	0°	8°	



TO-251 Package Information



Cumbal	Dimensions	In Millimeters	Dimensions In Inches	
Symbol	Min.	Max.	Min.	Max.
А	2.20	2.35	0.087	0.093
A1	0.90	1.10	0.035	0.043
b	0.56	0.69	0.022	0.027
b1	0.77	0.90	0.030	0.035
b2	5.23	5.43	0.206	0.214
b3		1.05	0.000	0.041
С	0.46	0.59	0.018	0.023
c1	0.46	0.59	0.018	0.023
D	6.00	6.20	0.236	0.244
D1	5.20		0.205	
E	6.50	6.70	0.256	0.264
E1	4.60	5.00	0.181	
e	2.24	2.34	0.088	0.092
e1	4.47	4.67	0.176	0.184
Н	16.18	16.78	0.637	0.661
L	9.00	9.60	0.354	0.378
L1	0.95	1.35	0.037	0.053
L2	0.90	1.25	0.035	0.049

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